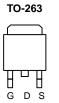


# N-Channel 30-V (D-S), 175°C MOSFET

PRODUCT SUMMARY			
V <sub>(BR)DSS</sub> (V)	r <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)	
30	0.013 @ V <sub>GS</sub> = 10 V	45 <sup>a</sup>	
	0.02 @ V <sub>GS</sub> = 4.5 V	45 <sup>a</sup>	

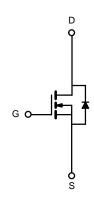
#### **FEATURES**

- TrenchFET® Power MOSFETS
- 175°C Junction Temperature



Top View

SUB45N03-13L



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25°C UNLESS OTHERWISE NOTED)					
Parameter Drain-Source Voltage Gate-Source Voltage		Symbol	Limit	Unit v	
		V <sub>DS</sub>	30 ±20		
		V <sub>GS</sub>			
Continuous Drain Current (T <sub>J</sub> = 175°C)	$T_C = 25^{\circ}C$	1	45 <sup>a</sup>		
	$T_C = 125^{\circ}C$	I <sub>D</sub>	34 <sup>a</sup>	Α	
Pulsed Drain Current		I <sub>DM</sub>	100		
Avalanche Current		I <sub>AR</sub>	45		
Repetitive Avalanche Energy <sup>b</sup>	L = 0.1 mH	E <sub>AR</sub>	100	mJ	
Maximum David Dissis disab	$T_{C} = 25^{\circ}C$	P	88 <sup>c</sup>	10/	
Maximum Power Dissipation <sup>b</sup>	$T_A = 25^{\circ}C^d$	P <sub>D</sub>	3.75		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount <sup>d</sup>	R <sub>thJA</sub>	40		
Junction-to-Case (Drain)		R <sub>thJC</sub>	1.7	°C/W	

Notes

Package limited. a.

b.

Duty cycle  $\leq$  1%. See SOA curve for voltage derating. When mounted on 1" square PCB (FR-4 material). c. d.

For SPICE model information via the Worldwide Web: http://www.vishay.com/www/product/spice.htm

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## SUB45N03-13L

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Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Static			•	1			
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A	30				
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{DS} = 250 \ \mu A$	1		3	v	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = $\pm20$ V			±100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μΑ	
	IDSS	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125^{\circ}\text{C}$			50		
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175^{\circ}\text{C}$			150		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 V, V_{GS} = 10 V$	45			Α	
		$V_{GS} = 10 \text{ V}, I_D = 45 \text{ A}$		0.009	0.013	- Ω	
		$V_{GS}$ = 10 V, $I_{D}$ = 45 A, $T_{J}$ = 125°C		0.013	0.02		
Drain-Source On-State Resistance <sup>a</sup>	rDS(on)	$V_{GS}$ = 10 V, $I_{D}$ = 45 A, $T_{J}$ = 175°C		0.02	0.026		
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.0145	0.02		
Forward Transconductance <sup>a</sup>		$V_{DS} = 15 \text{ V}, I_{D} = 45 \text{ A}$	20			S	
Dynamic <sup>b</sup>	<u> </u>		·				
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, f = 1 MHz		2000		pF	
Output Capacitance	C <sub>oss</sub>			370			
Reversen Transfer Capacitance	C <sub>rss</sub>			180			
Total Gate Charge <sup>c</sup>	Qg			40	70	nC	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 10 V, $I_{D}$ = 45 A		7.5			
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			8			
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			11	20	- ns	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = 15 V, R <sub>L</sub> = 0.33 $\Omega$		9	20		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \simeq 45$ A, $V_{GEN} = 10$ V, $R_G = 2.5 \Omega$		38	70		
Fall Time <sup>c</sup>	t <sub>f</sub>			11	20		
Source-Drain Diode Ratings a	nd Characteristic	s (T <sub>C</sub> = 25°C) <sup>b</sup>					
Continuous Current	١ <sub>s</sub>				45		
Pulsed Current	I <sub>SM</sub>				100	A 100	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_{F} = 45 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		1	1.3	V	
Reverse Recovery Time	t <sub>rr</sub>			35	70	ns	
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>	I <sub>F</sub> = 45 A, di/dt = 100 A/μs		1.7		Α	
Reverse Recovery Charge	Q <sub>rr</sub>			0.03		μC	

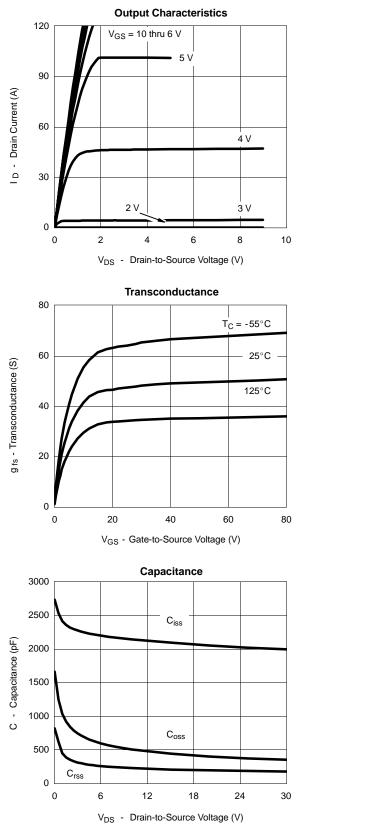
Notes:

a. Pulse test; pulse width  $\leq 300 \,\mu$ s, duty cycle  $\leq 2\%$ . e. Guaranteed by design, not subject to production testing. b. Independent of operating temperature.

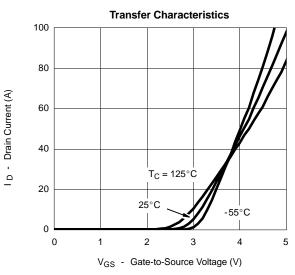


### SUB45N03-13L Vishay Siliconix

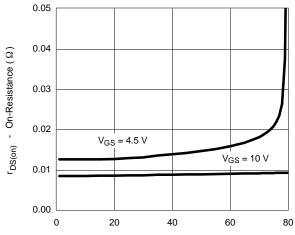
#### TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



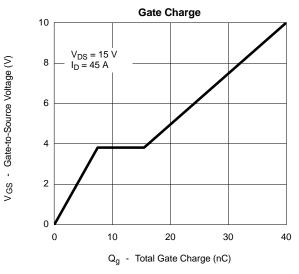
Document Number: 71740 S-05010—Rev. G, 05-Nov-01



**On-Resistance vs. Drain Current** 



I<sub>D</sub> - Drain Current (A)



#### **Vishay Siliconix**



Source-Drain Diode Forward Voltage

 $T_J = 25^{\circ}C$ 

1.2

1.5

T<sub>J</sub> = 150°C

0.3

0.6

V<sub>SD</sub> - Source-to-Drain Voltage (V)

0.9

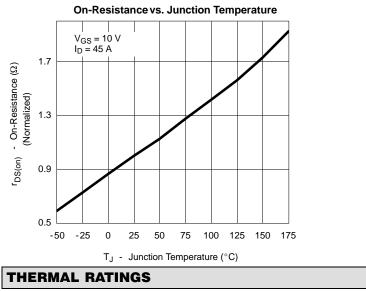
100

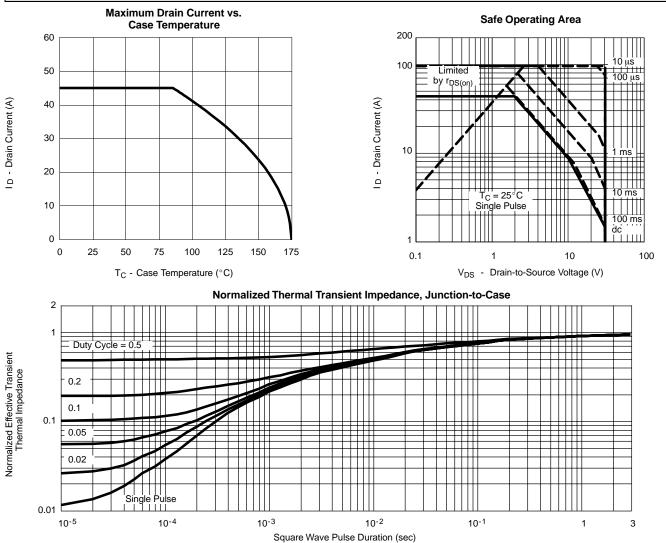
10

1

I S - Source Current (A)

#### TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)





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